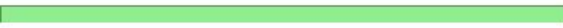
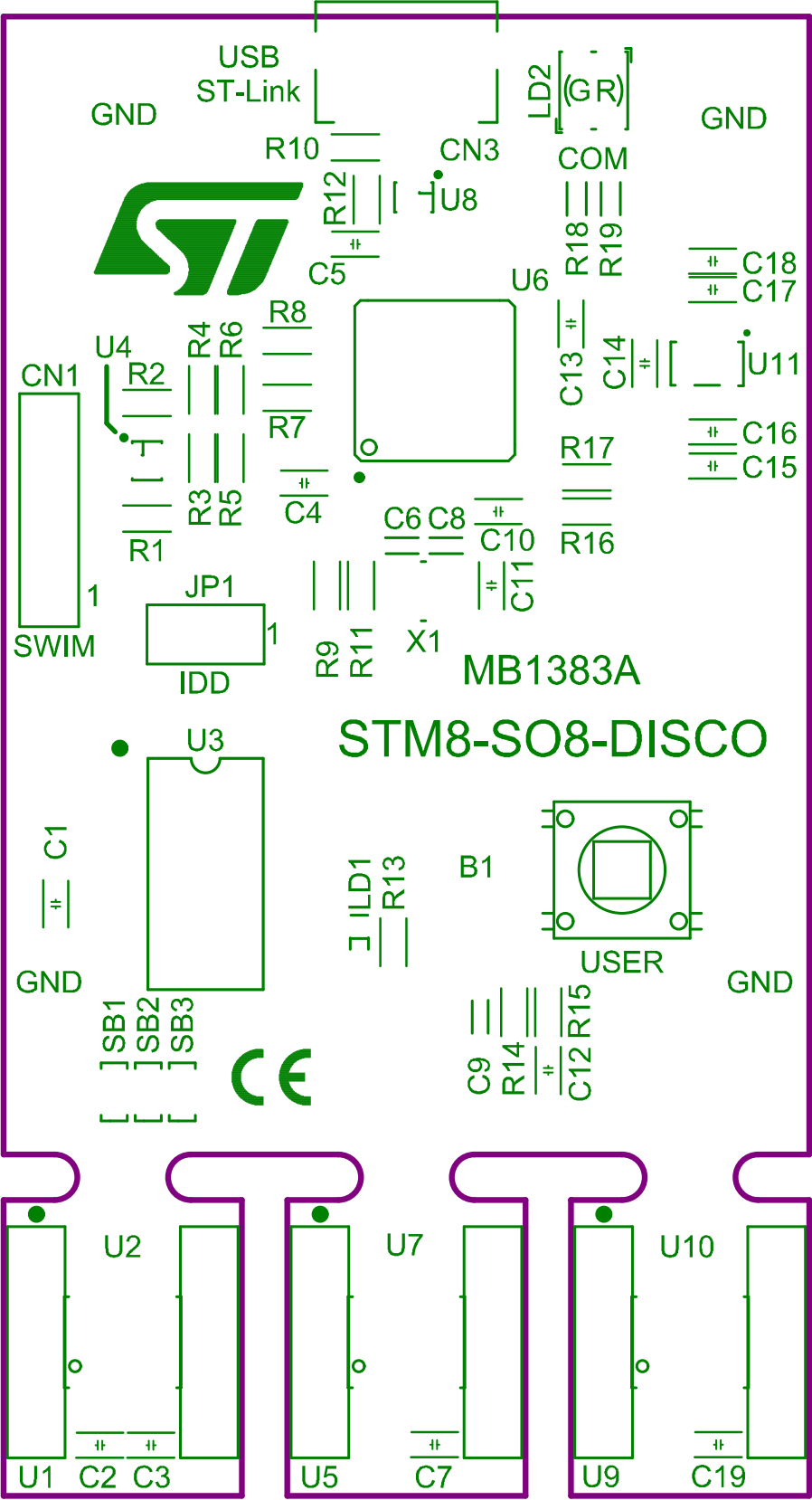


Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3	  	Top Solder	Solder Resist	0,015mm	3,5
4	  	Top Layer	Copper	0,035mm	
5		Dielectric 1	FR-4	1,500mm	4,8
6	  	Bottom Layer	Copper	0,035mm	
7	  	Bottom Solder	Solder Resist	0,015mm	3,5
8		Bottom Overlay			
9		Bottom Paste			
	Height : 1,600mm				

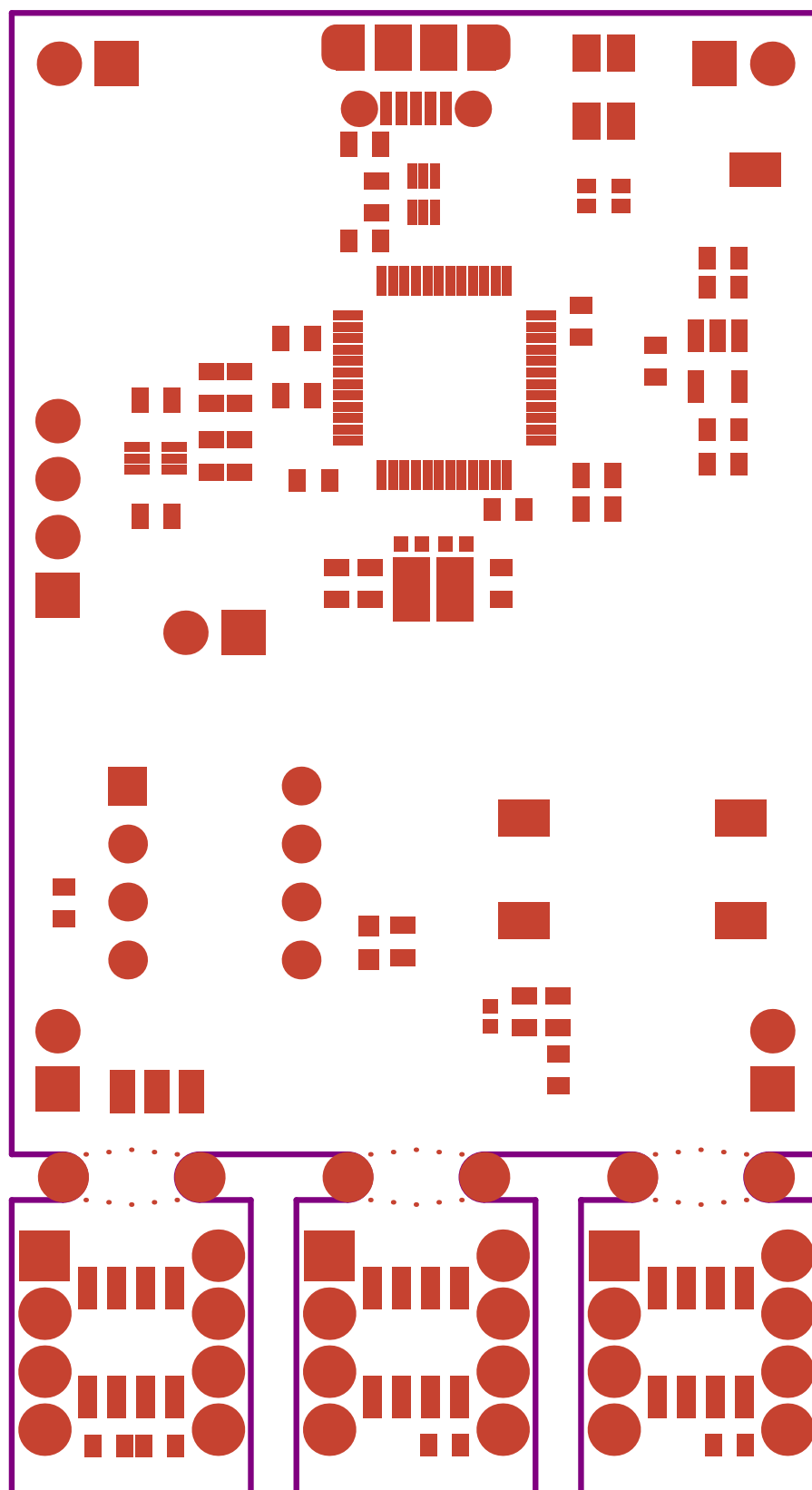
PCB characteristics:

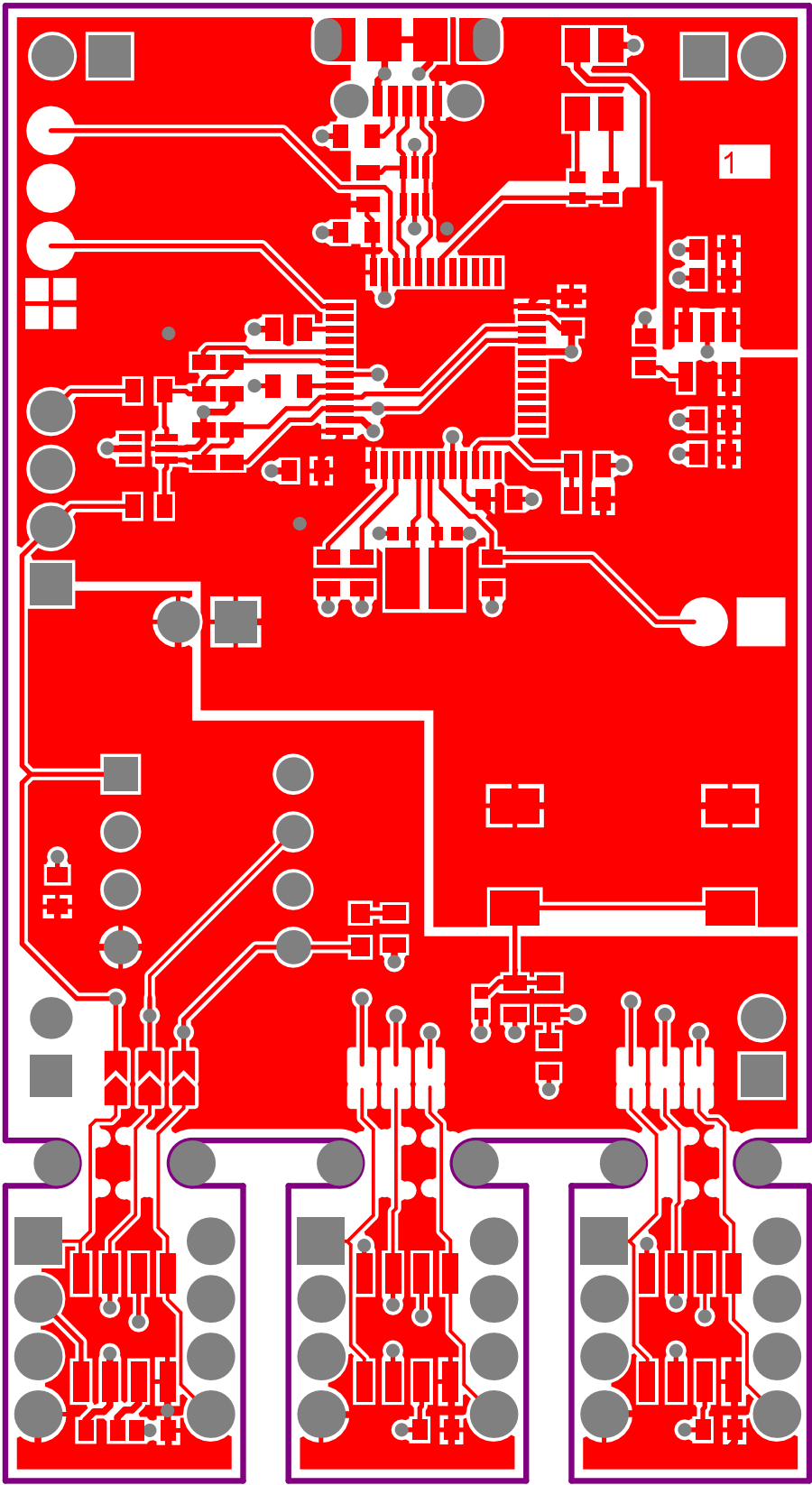
- Material: FR4 TG-140 or greater
- Soldermask color: Green
- Silkscreen color: White
- Plating type: Lead Gold



Top Solder

.GTS



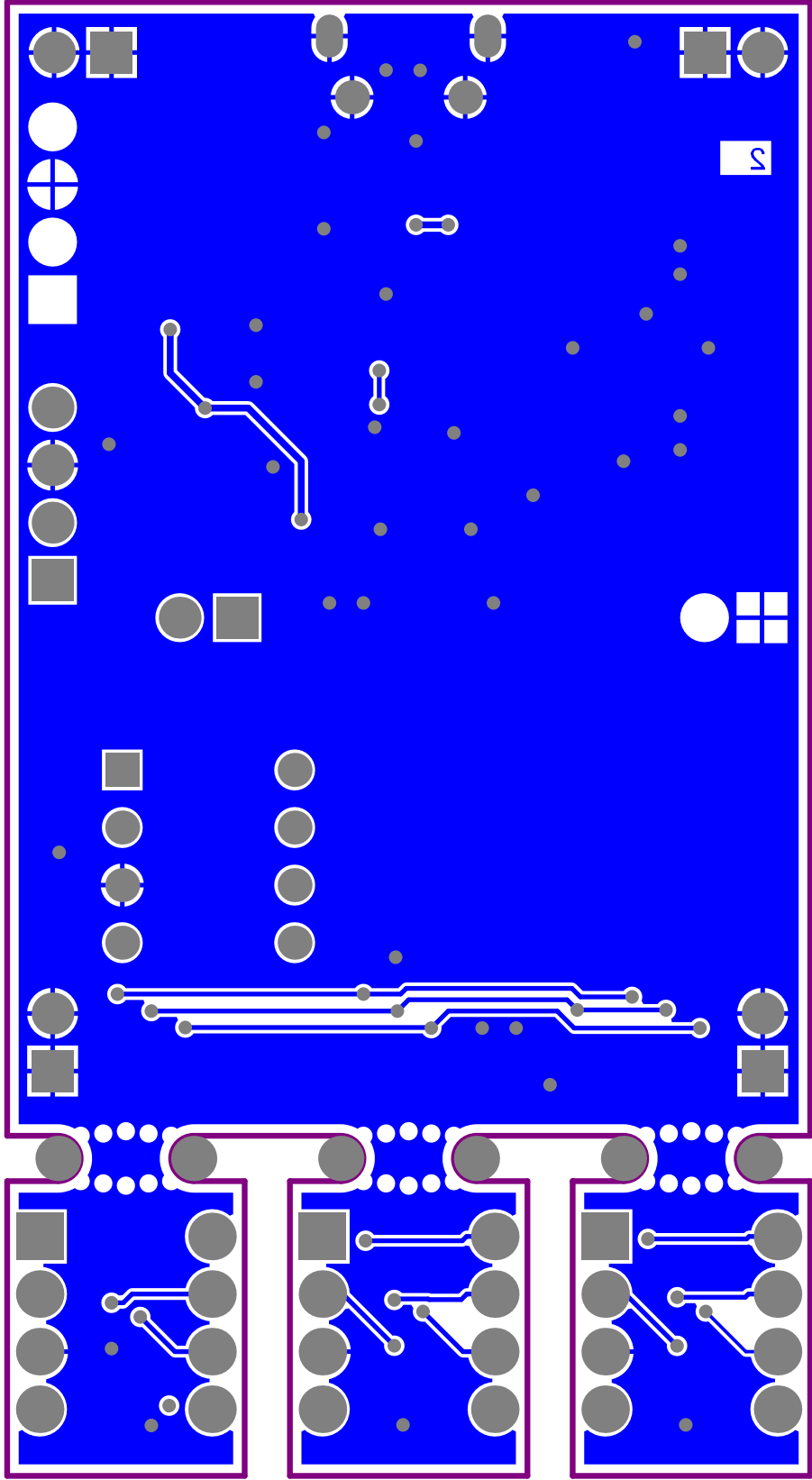


Top Layer

.GTL

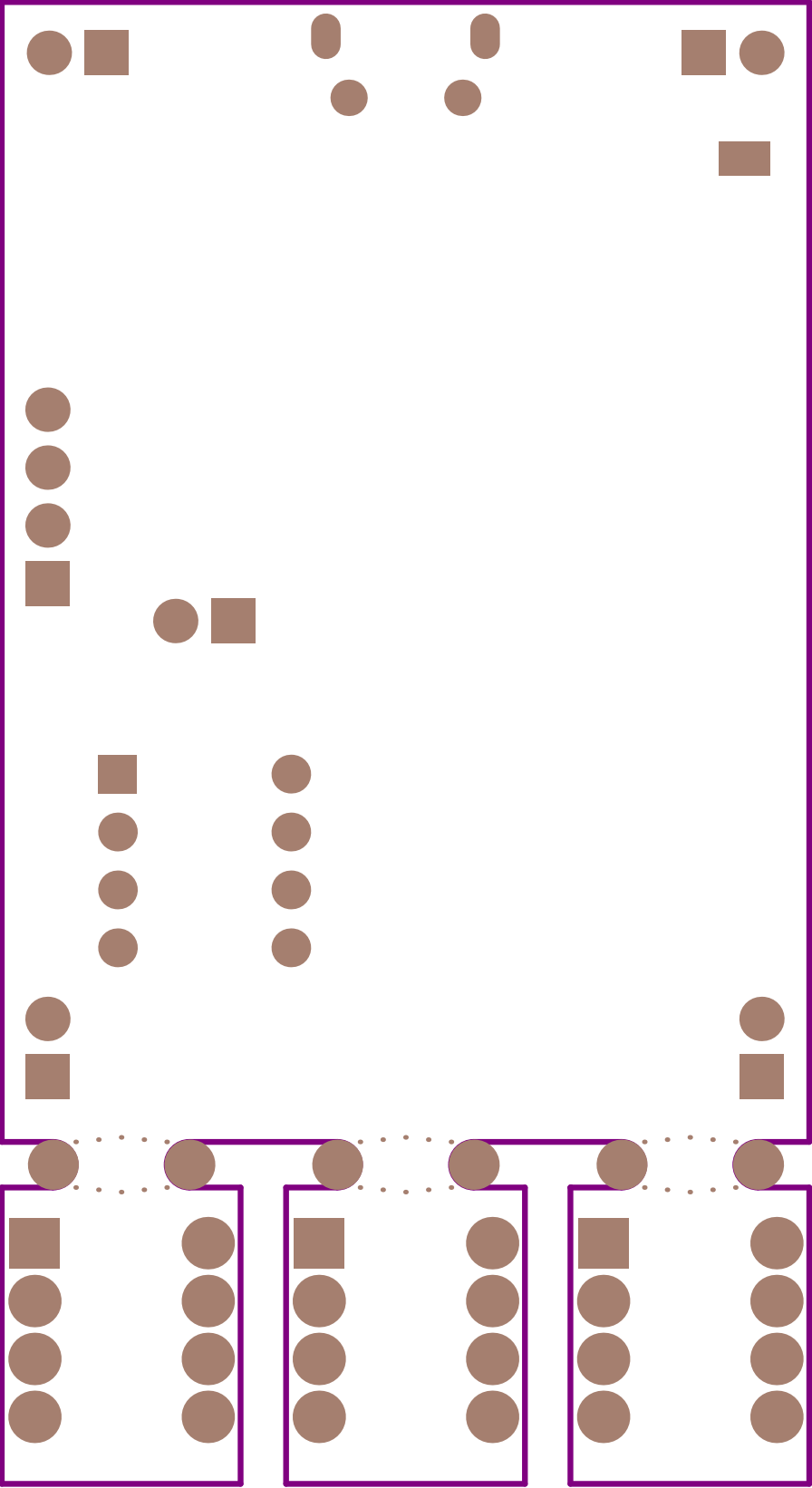
Bottom Layer

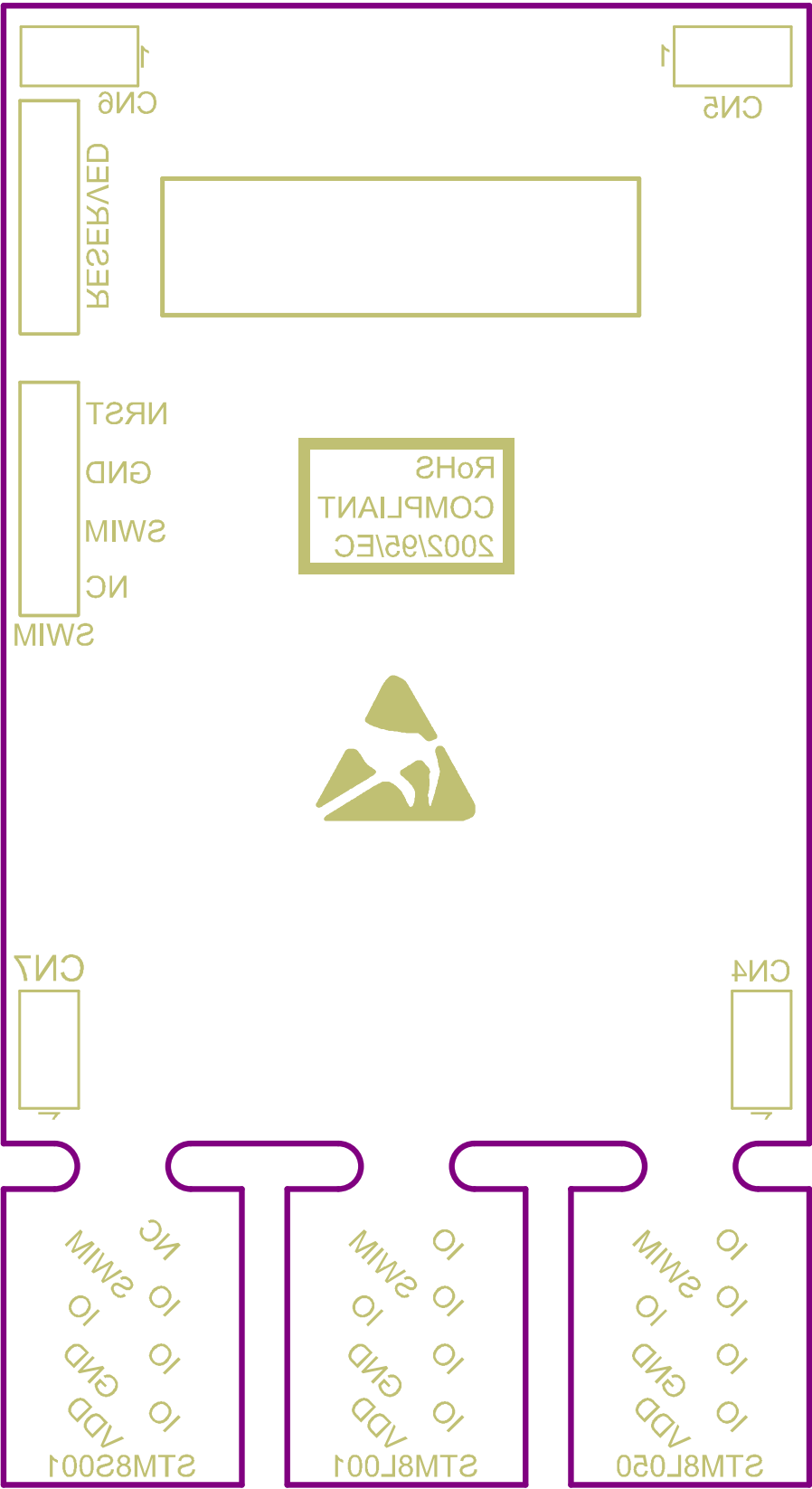
.GBL



Bottom Solder

.GB2





Symbol	Count	Hole Size	Hole Length	Routed Path Length
■	2	0,60mm (23,62mil)	1,30mm (51,18mil)	0,70mm (27,56mil)
◇	2	0,90mm (35,43mil)	-	-
☆	6	2,00mm (78,74mil)	-	-
□	24	1,55mm (61,02mil)	-	-
▽	28	1,00mm (39,37mil)	-	-
○	30	0,50mm (19,69mil)	-	-
⊕	64	0,30mm (11,81mil)	-	-
	156 Total			

Slot definitions : Routed Path Length = Calculated from tool start centre
Hole Length = Routed Path Length + Tool Size = Slot Length

